

JSKT120B

Description:

- 1) A package of series of two chips.
- 2) With high thermal conductivity DBC as the insulation.
- 3) Welding by vacuum welding technology, which provide high reliability.



Typical Application:

DC motor control, temperature control and light control system.

Absolute Maximum Ratings (Packaged into modules, unless otherwise specified, T_{CASE}=25℃)

Parameter	Test Conditions	Symbol	Values			
			12	16	18	Unit
Operating junction temperature range		Tj	-40-125			$^{\circ}$
Storage temperature range		T _{stg}	-40-125			$^{\circ}$ C
Repetitive peak off-state voltage	T _j =25℃	V_{DRM}	1200	1600	1600	V
Repetitive peak reverse voltage	T _j =25℃	V_{RRM}	1200	1600	1600	V
Non-repetitive peak off-state voltage	Tj=25℃	V _{DSM}	1400	1800	2000	V
Non-repetitive peak reverse voltage	Tj=25℃	V _{RSM}	1400	1800	2000	V
Average on-state current	Tc=85℃	I _{T(AV)}	120		А	
Peak on-state surge current	t _P =10ms V _R =0.6V _{RRM}	Ітѕм	2500		А	
I ² t value for fusing	t _P =10ms V _R =0.6V _{RRM}	l ² t	31250		A ² s	
Critical rate of rise of on-state current	I _G =2×I _{GT}	dl/dt	150		A/µs	
Isolation voltage	A.C 50Hz(1s/1min)	V _{ISO}	3600/3000		V	

Electrical Characteristics (Packaged into modules, unless otherwise specified, T_{CASE}=25°C)

Parameter	Test Conditions	Symbol	Values	Unit
Peak on-state voltage	I _T =360A t _P =380μs	V _{TM}	≤1.8	V
Threshold voltage	T _j =125℃	V _{TO}	≤0.95	V
Dynamic resistance	Tj=125℃	Rd	≤2.1	mΩ
	V _D =V _{DRM}			
Repetitive peak off-state current	Tc =25 ℃	I _{DRM1}	≤100	μΑ
	Tc=125℃	I _{DRM2}	≤40	mA



Repetitive peak reverse current	VR=VRRM Tc=25℃ Tc=125℃	Irrm1 Irrm2	≤100 ≤40	μA mA
Triggering gate current	V _D =12V R _L =30Ω	Ідт	20-120	mA
Holding current	I ⊤=1A	Ін	≤250	mA
Latching current	Ig=1.2 Igт	lι	≤300	mA
Triggering gate voltage	V _D =12V R _L =30Ω	V_{GT}	≤1.8	V
Non triggering gate voltage	V _D =V _{DRM} T _j =125°C	V_{GD}	≥0.25	V
Critical rate of rise of voltage	V _D =2/3V _{DRM} T _j =125℃ Gate Open	dv/dt	≥1000	V/µs
Thermal resistance	Junction to case Case to heatsink	Rth(j-c)	0.29 0.21	°C/W

Mechanical Characteristics

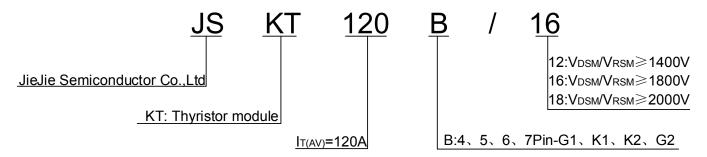
mechanical Characteristics			
Module size	95.2mm×22.7mm		
Module height	30.3mm		
Terminal distance of (1) /(2) /(3)	20mm		
Mounting torque(M5)	5±15%Nm		
Terminal torque(M5)	3±15%Nm		
4-2.8×0.80 95.2±0.75 3-M5 95.2±0.75 3-10 4-2.8×0.80 80.0±0.50 A 2:1 6.8 5.5 80.0±0.50 A T1	G2 (7) K2 (6) (1) K1 (5) G1 (4) Symbol		



Instructions and Precautions

- 1) There is no severe vibration and shock in operating environment, and there should be no impurity and atmosphere which may corrode metal and damage the insulation in the air-dielectric.
- 2) The operating condition of the product can't out of range of the above parameters.
- 3) When the product is installed on the radiator, the radiator's surface should be confirmed flat, smooth, wipe clean with alcohol, and coated evenly with a layer of thermal grease which thickness is moderate on the contact surface between product and radiator. When the module is fastened on the surface of the radiator, the M5 or M6 screws and spring washers are used and fastened with 5NM torque. After the module is operated 1 hour, all screws must be refastened.
- 4) The connection with the main electrode of module can use copper, welding, socket and so on. The contact surface should be smooth and flat, which make good contact. While the connection with the control electrode of module is installed, attention should be paid to the corresponding connection of each pin. After the completion of the connection, do not plug and pull out the lead of the control electrode freely.

Ordering Information



Performance Curves

0 0

IT(AV)(A)

100

120

140

160 180

FIG.1:Power dissipation vs. on-state current

FIG.2: Maximum transient thermal impedance junction to case(per thyristor)

R_{th(j-c)}(°C/W)

0.3

0.2

0.1

T_P(s)

1 10



FIG.3:Forward characteristics (per thyristor)

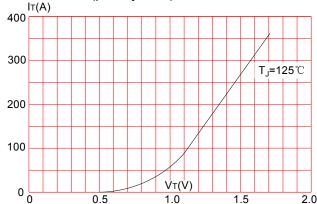
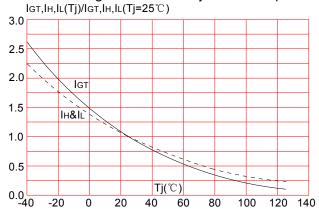


FIG.4: Relative variations of gate trigger current, holding current and latching current versus junction temperature



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